ST(意法) LM4041AELT-1.2 PDF

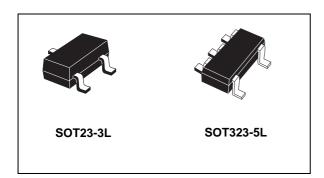
深圳创难电子有限公司

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Precision micropower shunt voltage reference

Datasheet - production data



Features

- Fixed 1.225 V typical output voltage
- Ultra low operating current: 40 µA at 25 °C
- High precision: +/- 0.1% @ 25 °C (0.2%, 0.5% and 1% versions are also available)
- · Stable when used with capacitive loads
- Industrial (- 40 to+ 85 °C) and Extended (- 40 to +125 °C) temperature range versions available
- 100 ppm/°C maximum temperature coefficient
- Available in SOT23-3L and SOT323-5L packages

Applications

- Computers
- Battery chargers
- Switch mode power supply
- · Battery operated equipment
- Data acquisition systems
- Energy management
- Instrumentation

Description

The LM4041 is a micropower shunt voltage reference, providing a stable 1.225 V output voltage, with an initial accuracy of 0.1% @ 25 °C and a low temperature coefficient. Available in SOT323-5L and SOT23-3L surface mount packages, it can be designed in applications where space saving is a critical issue. The low operating current is a key advantage for power restricted designs. In addition, the LM4041 is very stable and can be used in a broad range of application conditions.

Contents LM4041

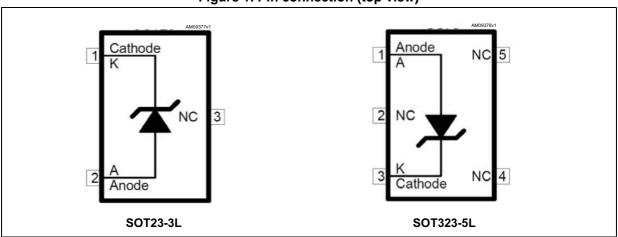
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LM4041 Pin configuration

1 Pin configuration

Figure 1. Pin connection (top view)



Note: Below pins must be left floating or connected to Anode pin to improve noise immunity due to PCB layout.

SOT23-3L: pin 3.

SOT323-5L: pin 2, pin 4 and pin 5.

Maximum ratings LM4041

2 Maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
I _K	Reverse breakdown current	20	mA
V _K	Maximum cathode voltage	8	V
I _F	Forward current	10	mA
P _D	Power dissipation ⁽¹⁾ SOT23-3L SOT323-5L	500 536	mW
T _{STG}	Storage temperature	- 65 to +150	°C
	Human body model (HBM)	2	kV
ESD	Machine model (MM)	200	V
	Charged device model	1500	V
T _{LEAD}	Lead temperature (soldering) 10 sec	260	°C
TJ	Max junction temperature	+150	°C

^{1.} P_D has been calculated with $T_{AMB} = 25$ °C and $T_{JMAX} = 150$ °C.

Note:

Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 2. Thermal data

Symbol	Parameter	SOT323-5L	SOT23-3L	Unit
R _{thJA}	Thermal resistance junction-ambient	233	248	°C/W
R _{thJC}	Thermal resistance junction-case	90	136	°C/W

Table 3. Operating conditions

Symbol	Parameter	Value	Unit	
I _{KMIN}	Minimum operating current 40			
I _{KMAX}	Maximum operating current		12	mA
T		Industrial	- 40 to + 85	°C
OPER	Operating free air temperature range Extended		- 40 to + 125	

3 Electrical characteristics

T_{AMB} = 25 °C, unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{\mathbf{k}}$	Reverse breakdown voltage	I _k = 100 μA LM4041A, 0.1% LM4041B, 0.2% LM4041C, 0.5% LM4041D, 1%	1.2238 1.2225 1.219 1.213	1.225	1.2262 1.2275 1.231 1.237	V
I _{kmin}	Minimum operating current	T _{amb} = 25 °C -40 °C < T _{amb} < T _{max} ⁽¹⁾		25	40 50	μΑ
$\Delta V_{k}/\Delta T$	Average temperature coefficient (2)	I _k = 100 μA		± 36	± 100	ppm/°C
AN/ /AI	Reverse breakdown voltage change with	$I_{kmin} < I_k < 1 \text{ mA}$ - 40 °C < $T_{amb} < T_{max}$ (1)		0.4	1 1.5	mV
	operating current range	1 mA < I _k < 12 mA - 40 °C < T _{amb} < T _{max} ⁽¹⁾		4	8 10	IIIV
R _{ka}	Static impedance	$\Delta I_k = 100 \mu A \text{ to 1 mA}$		0.4	1	W
K _{vh}	Long term stability	$I_k = 100 \mu\text{A}, t = 1000 \text{hrs}$		120		ppm
e _n	Wide band noise	I _k = 100 μA, 10 Hz < f < 10 kHz		60		μV_{RMS}

^{1.} T_{max} = 85 °C for LM4041xI (industrial version) and T_{max} = 125 °C for LM4041xE (extended version).

Note: Limits are 100% production tested at 25 °C. Limits over temperature are guaranteed through correlation and by design.

 $^{2. \}quad \text{The average temperature coefficient is defined as: } \\ 10^6 \text{ x } \\ \{\text{max}(\Delta V_k) \ / \ [V_{\text{k@25°C}} \ \text{x } \ (T_{\text{max}} - T_{\text{min}})]\} \ [\text{ppm/°C}]. \\ (10^6 \text{ cm}) \\ (10^6$

4 Typical performance characteristics

The following plots are referred to the typical application circuit and, unless otherwise noted, at $T_A = 25 \, ^{\circ}\text{C}$.

Figure 2. V_k change vs. temperature

Figure 3. Minimum current for regulation

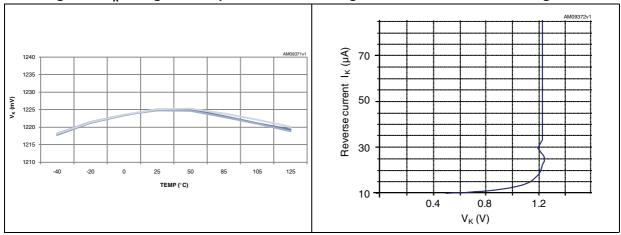
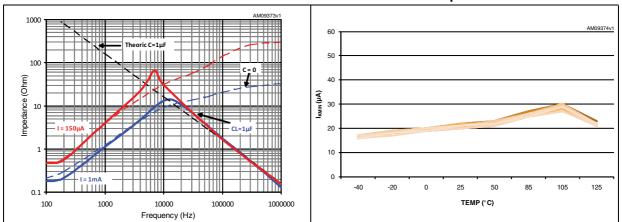


Figure 4. Output impedance vs. frequency

Figure 5. Minimum current for regulation vs. temperature



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Figure 6. Startup characteristics

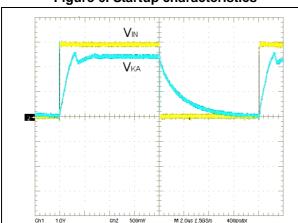


Figure 7. Startup measure circuit

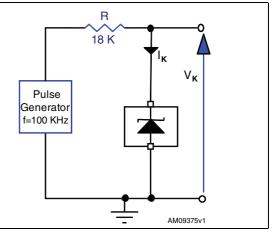
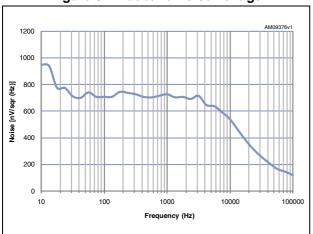


Figure 8. Wideband noise voltage



5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions, and product status are available at: www.st.com. ECOPACK is an ST trademark.

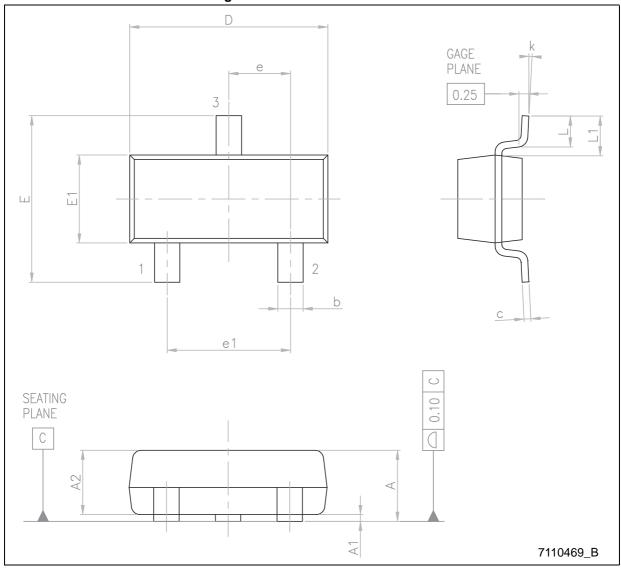


Figure 9. SOT23-3L dimensions

Table 5. SOT23-3L mechanical data

Dim.		mm.	
Dilli.	Min.	Тур.	Max.
А	0.89		1.12
A1	0.01		0.10
A2	0.88	0.95	1.02
b	0.30		0.50
С	0.08		0.20
D	2.80	2.90	3.04
E	2.10		2.64
E1	1.20	1.30	1.40
е		0.95	
e1		1.90	
L	0.40	0.50	0.60
L1		0.54	
k	0°		8°



SIDE VIEW À2 GAUGE PLANE A^{\dagger}_{1} O.1 C

COPLANAR LEADS -C 0,15 SEATING PLANE E/2 E1/2 $\mathbf{1}$ $\mathbf{E}_{\mathbf{1}}^{\mathbf{1}}$ **b** Nx (5 LEADS) TOP VIEW 7091413/E

Figure 10. SOT323-5L dimensions



Table 6. SOT323-5L mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
А	0.80		1.10
A1	0		0.10
A2	0.80	0.90	1
b	0.15		0.30
С	0.10		0.22
D	1.80	2	2.20
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
е		0.65	
e1		1.30	
L	0.26	0.36	0.46
<	0°		8°

6 Packaging mechanical data

A Po Note: Drawing not in scale

Figure 11. Tape and reel SOT23-3L and SOT323-5L mechanical drawing

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Table 7. Tape and reel SOT23-3L mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
А			180
С	12.8	13.0	13.2
D	20.2		
N	60		
Т			14.4
Ao	3.13	3.23	3.33
Во	3.07	3.17	3.27
Ко	1.27	1.37	1.47
Ро	3.9	4.0	4.1
Р	3.9	4.0	4.1

Table 8. SOT323-5L mechanical data

Dim.		mm.	
Dilli.	Min.	Тур.	Max.
А	175	180	185
С	12.8	13	13.2
D	20.2		
N	59.5	60	60.5
Т			14.4
Ao		2.25	
Во		2.7	
Ko		1.2	
Po	3.9	4	4.1
Р	3.8	4	4.2



Order codes LM4041

7 Order codes

Table 9. Order codes

Order codes	Precision	Packages	Operating temperature range	Marking
LM4041AICT-1.2	0.1%			L2
LM4041BICT-1.2	0.2%	SOT323-5L	Industrial	L2
LM4041CICT-1.2	0.5%	301323-5L	- 40 to + 85 °C	L25
LM4041DICT-1.2	1%			L26
LM4041AILT-1.2	0.1%			L23
LM4041BILT-1.2	0.2%	SOT22 21	Industrial	L24
LM4041CILT-1.2	0.5%	SOT23-3L	- 40 to + 85 °C	L25
LM4041DILT-1.2	1%			L26
LM4041AECT-1.2	0.1%			E2
LM4041BECT-1.2	0.2%	SOT323-5L	Extended	E2
LM4041CECT-1.2	0.5%	501323-5L	- 40 to + 125 °C	E25
LM4041DECT-1.2	1%			E26
LM4041AELT-1.2	0.1%			E23
LM4041BELT-1.2	0.2%	SOT22 21	Extended	E24
LM4041CELT-1.2	0.5%	SOT23-3L	- 40 to + 125 °C	E25
LM4041DELT-1.2	1%			E26

LM4041 Revision history

8 Revision history

Table 10. Document revision history

Date	Revision	Changes
09-May-2011	1	Initial release.
05-Dec-2011	2	Changed maturity code and updated Table 9 on page 14.
25-Jul-2012	3	Added: marking order codes Table 9 on page 14.
18-Feb-2014	4	Part number LM4041xx changed to LM4041. Updated <i>Table 1: Absolute maximum ratings</i> , <i>Section 1: Pin configuration</i> and <i>Section 5: Package mechanical data</i> . Added <i>Section 6: Packaging mechanical data</i> . Minor text changes.

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